# 2SB0643, 2SB0644 (2SB643, 2SB644)

### Silicon PNP epitaxial planar type

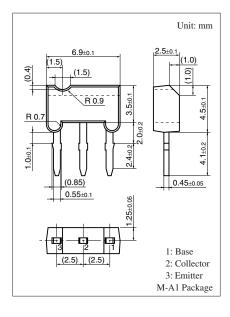
For low-frequency general amplification

#### Features

• M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB0643	V <sub>CBO</sub>	-30	V
(Emitter open)	2SB0644		-60	
Collector-emitter voltage	2SB0643	V <sub>CEO</sub>	-25	V
(Base open)	2SB0644		-50	
Emitter-base voltage (Coll	V <sub>EBO</sub>	-7	V	
Collector current	I <sub>C</sub>	- 0.5	А	
Peak collector current	I <sub>CP</sub>	-1	А	
Collector power dissipatio	P <sub>C</sub>	600	mW	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	





#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage	2SB0643	V <sub>CBO</sub>	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$	-30			V
(Emitter open)	2SB0644			-60			
Collector-emitter voltage	2SB0643	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-25			V
(Base open)	2SB0644			-50			
Emitter-base voltage (Collector open)		V <sub>EBO</sub>	$I_E = -10 \ \mu A, \ I_C = 0$	-7			V
Collector-base cutoff current (Emitter open)		I <sub>CBO</sub>	$V_{CB} = -20 \text{ V}, I_E = 0$			- 0.1	μΑ
Collector-Emitter cutoff current (Base open)		I <sub>CEO</sub>	$V_{CE} = -20 \text{ V}, I_B = 0$			-1	μΑ
Forward current transfer ratio *1		h <sub>FE1</sub> *2	$V_{CE} = -10 \text{ V}, I_C = -10 \text{ mA}$	85		340	
		h <sub>FE2</sub>	$V_{CE} = -10 \text{ V}, I_C = -500 \text{ mA}$	40	90		_
Collector-emitter saturation voltage *1		V <sub>CE(sat)</sub>	$I_{\rm C} = -300 \text{ mA}, I_{\rm B} = -30 \text{ mA}$		- 0.35	- 0.6	V
Transition frequency		f <sub>T</sub>	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance		C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6	15	pF
(Common base, input open circuited)							

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

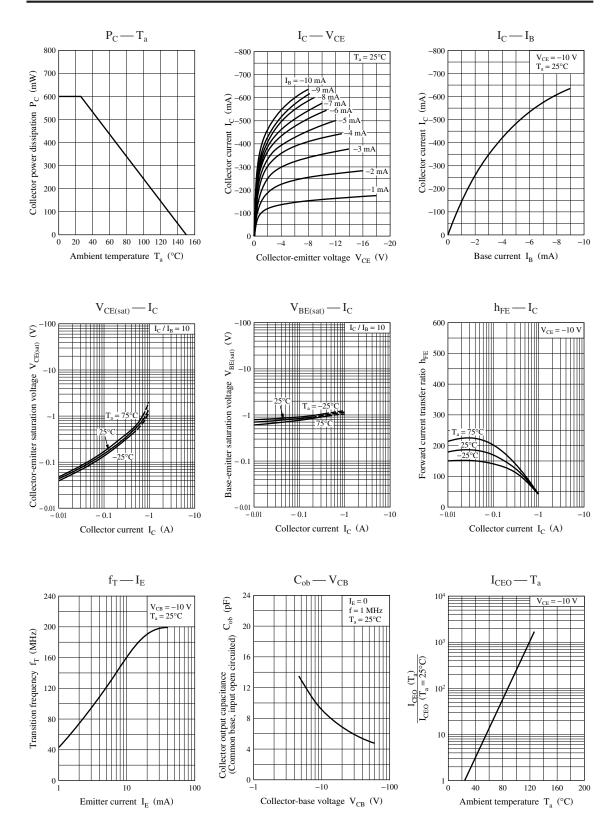
2. \*1: Pulse measurement

\*2: Rank classification

Rank	Q	R	S
h <sub>FE1</sub>	85 to 170	120 to 240	170 to 340

Note) The part numbers in the parenthesis show conventional part number.

### Panasonic



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